

# **Making Every Connection Better**

Precise Clock for Seamless Synchronization & Ultimate Data Transmission

# ThermSym<sup>™</sup> OCXO **Product Brief**

## Think of Frequency Think of TXC



Bridge Smarter Connectivity for Advanced Networks

https://www.txccorp.com



## ThermSym OCXO

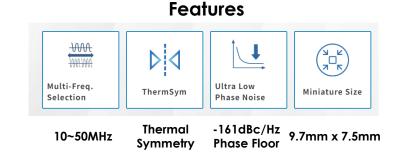
#### ThermSym<sup>™</sup> OCXO Family



OE Series 14mm x 9mm



OG Series 9mm x 7mm



# Empowering 5G Synchronization

#### Introduction

TXC has used its extensive package design experience to develop a novel patented OCXO technology. The industry first SC-cut crystal IC OCXO in a small form package using TXC's patented ThermSym (Thermal Symmetry) technology with a heater-embedded ceramic package provides excellent thermal performance compared to conventional IC OCXO oven structure (Thermal Asymmetry). The SC-cut crystal of the ThermSym OCXO with better quality factor further enhances the phase noise, short-term stability, aging performance, etc.



### **ThermSym OCXO** Empowering 5G Synchronization

#### **TXC** ThermSym<sup>™</sup>Technology (::) (**C**) 95 Symmetric thermal field Thermal Symmetry Better Oven Stability + Better Reliability Crystal~94.6 C 94 Crystal blank in the ceramic package 93 Embedded Heater~95 °C Cover 92 IC is attached on the bottom **IC~94.8**℃ 91 of the ceramic package Heater embedded in the ceramic package 90 A sectional view 🙁 Conventional IC OCXO Structure Asymmetric thermal field **(C)** 95 Crystal~91.2 °C 94 **Embedded Heater** 93 PCB substrate 92 IC~95°C 91 Protected by US patents 90 Heat source from power transistor on IC

#### **Applications & Compliance Support**

- Small Cell
- RRU/AAU
- PTP enable Switch/Router
- Smart power grid synchronization
- Packet Based Telecom Time Slave Clock on G.8273.2
- SyncE Ethernet Equipment Clocks based on G.8262
- Enhanced Ethernet Equipment Clocks based on G.8262.1
- Telecom Transparent Clocks based on G.8273.3

#### Benefits

Feature	Benefits
ThermSym Technology Thermal Symmetry patented technology	<ul> <li>Thermal Symmetry patented technology with a heater-embedded ceramic package provides excellent thermal performance.</li> <li>Better reliability compared to the solution that uses the embedded heater in the IC.</li> </ul>
Integrated Circuit Technology Advanced oven control algorism	IC based, superior reliability compared to traditional discrete OCXO
Excellent frequency stability <±20ppb over -40 to 95°C	<ul> <li>Fully compliant with RRU, small cell, optical module and microwave transmission system applications.</li> </ul>
<b>High-Q SC-Cut Crystal Unit</b> Innovative in-house developed initiatives and solutions <161 dBc/Hz at phase floor	<ul> <li>Higher Q-factor and better short-term and long-term stability compared to AT-cut crystal and MEMS resonator</li> <li>Resilient to airflow interference</li> <li>Enable RRU PLLs to use a single mode to meet both wander and jitter performance for network synchronization and air interface requirements</li> </ul>